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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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2SA1374

Silicon PNP Epitaxial



ADE-208-1016 (Z) 1st. Edition Mar. 2001

Application

Low frequency amplifier

Outline



2SA1374

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	-55	V
Collector to emitter voltage	V_{CEO}	-55	V
Emitter to base voltage	V_{EBO}	-5	V
Collector current	I _c	-100	mA
Base current	I _B	-30	mA
Collector power dissipation	P _c	300	mW
Junction temperature	Тј	150	°C
Storage temperature	Tstg	-55 to +150	°C

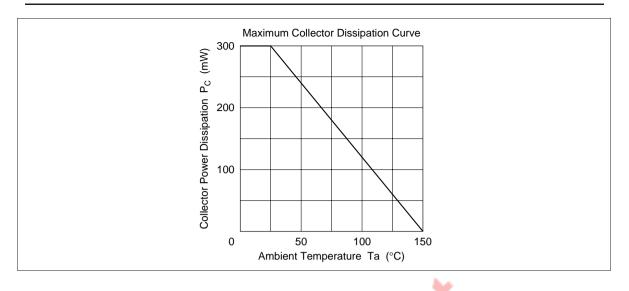
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	-55	_	\rightarrow	V	$I_{c} = -10 \ \mu A, \ I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	- 55	(4	V	$I_{\rm C} = -1$ mA, $R_{\rm BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	-5	1		V	$I_{E} = -10 \ \mu\text{A}, \ I_{C} = 0$
Collector cutoff current	I _{CBO}	-/	_	-0.1	μΑ	$V_{CB} = -18 \text{ V}, I_{E} = 0$
Emitter cutoff current	I _{EBO}	_ `	_	-0.05	μΑ	$V_{EB} = -2 \text{ V}, I_{E} = 0$
DC current transfer ratio	h _{FE} *1	160	_	500		$V_{CE} = -12 \text{ V}, I_{C} = -2 \text{ mA}$
Base to emitter voltage	V _{BE}	_	-0.66	-0.75	V	$V_{CE} = -12 \text{ V}, I_{C} = -2 \text{ mA}$
Collector to emitter saturation voltage	V _{CE(sat)}	_	-0.1	-0.5	V	$I_{\rm C} = -10 \text{ mA}, I_{\rm B} = -1 \text{ mA}$
Gain bandwidth product	f⊤	_	250	_	MHz	$V_{CE} = -12 \text{ V}, I_{C} = -2 \text{ mA}$
Collector output capacitance	Cob	_	2.5	_	pF	$V_{CB} = -10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$

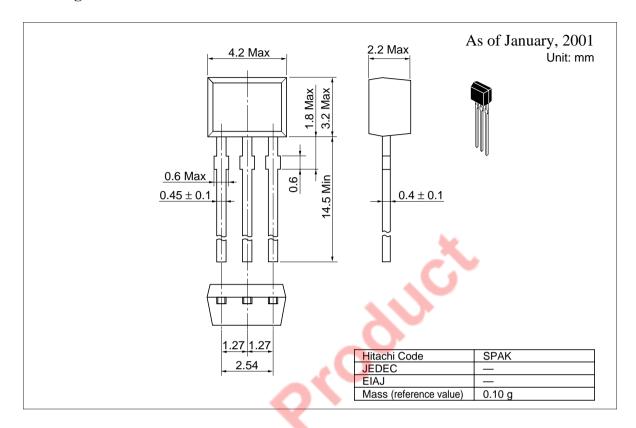
Note: 1. The 2SA1374 is grouped by h_{FE} as follows.

С	D
160 to 320	250 to 500

See characteristic curves of 2SA836.



Package Dimensions



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